

APPLICATION DATA SHEET
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Title of Invention	TILE-BASED ROUTING METHOD OF A MULTI-LAYER CIRCUIT BOARD AND RELATED STRUCTURE
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Application Type: regular, utility  
Attorney Docket Number: SISP0002USA

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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.